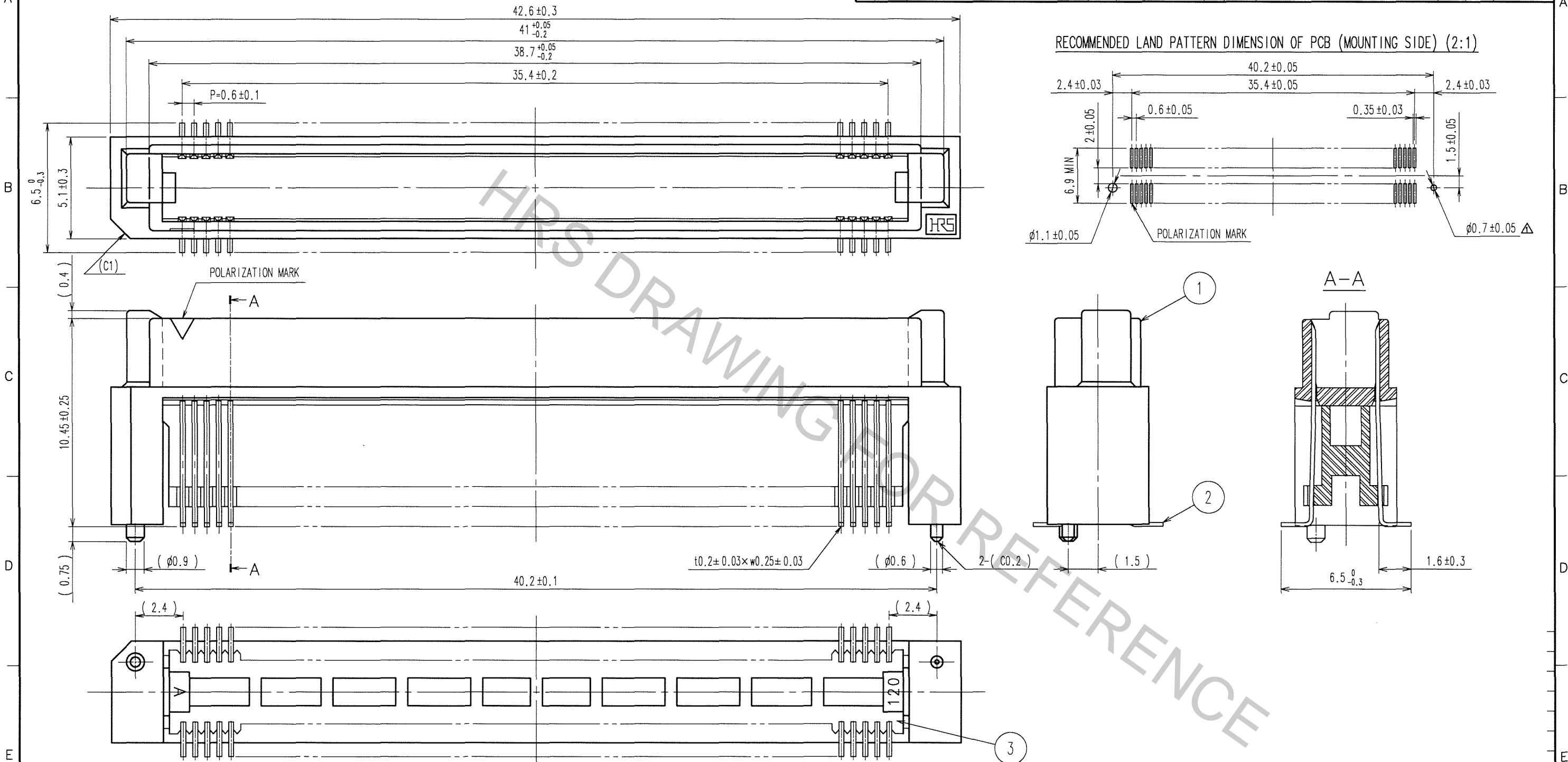
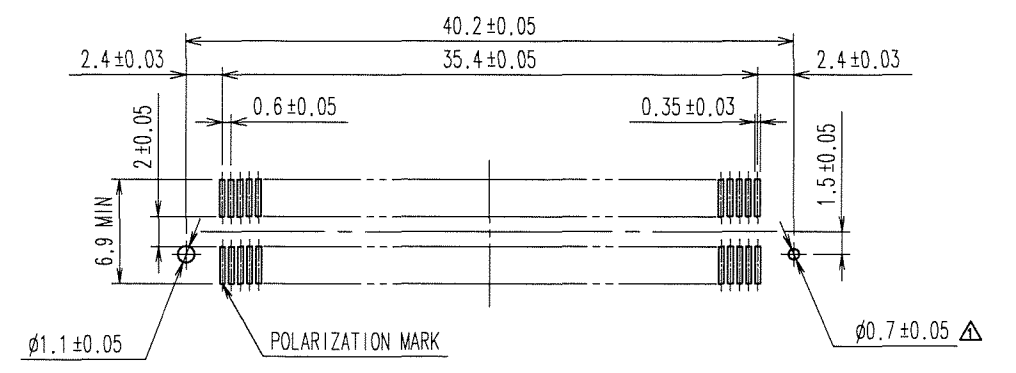


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COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
1	DIS-F-001011	K.D	H.O	06.09.27					



RECOMMENDED LAND PATTERN DIMENSION OF PCB (MOUNTING SIDE) (2:1)



- NOTE 1. LEAD CO-PLANARITY SHALL BE 0.1mm MAX.  
 2. FOR MODIFICATION, ETC., PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED ACCORDING TO CIRCUMSTANCES.  
 3. THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
1, 3	POLYPHENYLENE SULFIDE	LIGHT BROWN (UL94V-0)	2	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1μm min. LEAD AREA: TIN 1μm min. UNDER PLATING: NICKEL 1μm min.

CODE NO. (OLD)	DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED
CL	K.DOI	K.DOI	H.OZAWA	H.OKAWA	
	'05.09.13	'05.09.13	'05.09.13	'05.09.13	

SCALE	DRAWING NO.	PART NO.
5 : 1	EDC3-150874-25	FX8C-120P-SV6(71)
UNITS	DRAWING NO.	CODE NO.
mm	HRS HIROSE ELECTRIC CO., LTD	CL578-0606-7-71

TO